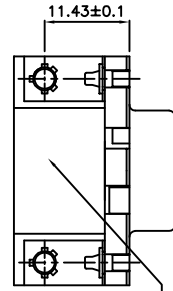


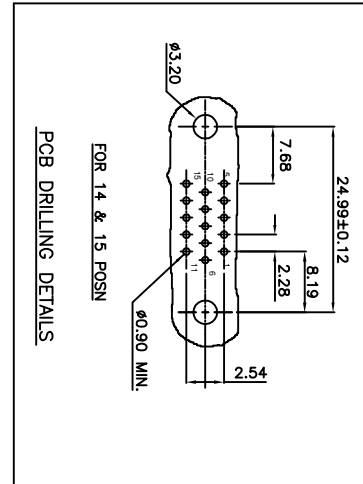
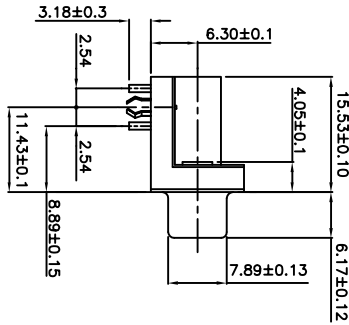
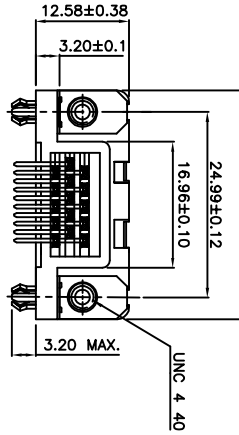


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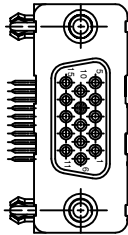


PCB DRILLING DETAILS

TECHNICAL SPECIFICATIONS

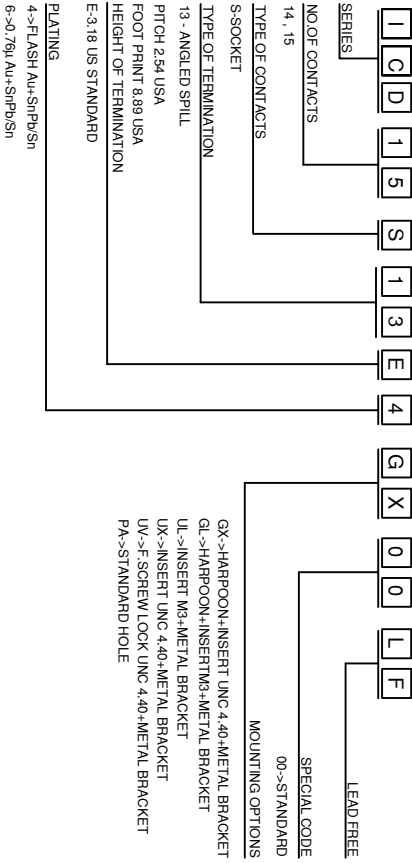
MATERIAL : STEEL TIN/ZINC O3 PLATED
SHELL : SELF EXTINGUISHING BLACK POLYESTER UL CLASS 94V0
INSULATORS : THE HOUSING WILL WITHSTAND EXPOSURE TO 260-285°C
CONTACTS : IF WE USE PROTECTIVE ADHESIVE (Type Kapton or Teflon) OR PROTECTIVE METALLIC DEVICE
PLATING : GOLD OVER NICKEL
ACTIVE ZONE : TIN LEAD OVER NICKEL
TERMINATION ZONE : 24UMIN MATE TIN TOP OVER 1.27UMIN NICKEL UNDER PLATE(TON TERMINATION ZONE)
FOR LEAD FREE PLATING : BRASS, TIN/ZINC O3 PLATED, BRASS, TIN PLATED, BRASS, TIN/ZINC O3 PLATED, BRASS, TIN/ZINC O3 PLATED, BRASS, TIN/ZINC O3 PLATED.

ELECTRICAL DATA : 3A
TEST VOLTAGE : 1000V
RATED VOLTAGE : 300V
CONTACT RESISTANCE : ≤25mΩ
SHELL RESISTANCE : ≤5mΩ
INSULATION RESISTANCE : >5000MΩ
ENVIRONMENTAL CHARACTERISTICS : -55°C - +125°C
OPERATING TEMPERATURE RANGE :
MECHANICAL CHARACTERISTICS : MATING/UNMATING CYCLES (MIN) : 200 (FLASH Au); 500 (0.75μ Au)
INSERTION/EXTRACTION FORCE PER CONTACT : 5 N MAX.; 0.3 N MIN.



FOR 14 POSN, HOLE NO. 9 IS BLOCKED.

ORDERING INFORMATION



"This product meets European Union Directives and other country regulations as described in GS-22-008"
The housing will withstand exposure to 260°C peak temperature for 3.5 seconds in a wave solder application with a 1.6mm minimum thick circuit board.
Packaging as per GS-14-920

Table with columns: mat'l. code, SEE NOTE 4, surface tolerance, ISO 1302, ISO 406 ISO 1101, projection, product family, title, sheet no, revision, date, date, angles, linear, scale, dwg no, sheet 1 of 1, size, sheet index, revision, sheet, index.

form: A3

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